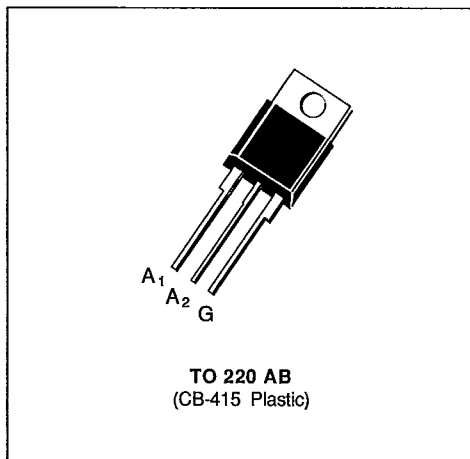


SNUBBERLESS TRIACS

- $I_{TRMS} = 8\text{ A}$ at $T_c = 90\text{ }^\circ\text{C}$.
- $V_{DRM} : 200\text{ V}$ to 800 V .
- $I_{GT} = 75\text{ mA}$ (QI-II-III).
- GLASS PASSIVATED CHIP.
- HIGH SURGE CURRENT : $I_{TSM} = 80\text{ A}$.
- HIGH COMMUTATION CAPABILITY :
(di/dt)_c > 10 A/ms without snubber.
- INSULATING VOLTAGE : 2500 V_{RMS} .



DESCRIPTION

New range suited for applications such as phase control and static switching on inductive or resistive load.

ABSOLUTE RATINGS (limiting values)

Symbol	Parameter		Value	Unit
I_{TRMS}	RMS on-state current (360 ° conduction angle)	$T_c = 90\text{ }^\circ\text{C}$	8	A
I_{TSM}	Non repetitive surge peak on-state current (T_j initial = $25\text{ }^\circ\text{C}$)	$t = 8.3\text{ ms}$	85	A
		$t = 10\text{ ms}$	80	
I^2t	I^2t value	$t = 10\text{ ms}$	32	A^2s
di/dt	Critical rate of rise of on-state current (1)	Repetitive $F = 50\text{ Hz}$	20	$\text{A}/\mu\text{s}$
		Non Repetitive	100	
T_{stg} T_j	Storage and operating junction temperature range		- 40, + 150 - 40, + 125	$^\circ\text{C}$ $^\circ\text{C}$

Symbol	Parameter	BTA 08-					Unit
		200 AW	400 AW	600 AW	700 AW	800 AW	
V_{DRM}	Repetitive peak off-state voltage (2)	± 200	± 400	± 600	± 700	± 800	V

(1) Gate supply : $I_G = 750\text{ mA}$ - $di_G/dt = 1\text{ A}/\mu\text{s}$.

(2) $T_j = 125\text{ }^\circ\text{C}$.

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THERMAL RESISTANCES

Symbol	Parameter	Value	Unit
$R_{th(j-a)}$	Junction to ambient	60	°C/W
$R_{th(j-c)}$ DC	Junction to case for DC	4.3	°C/W
$R_{th(j-c)}$ AC	Junction to case for 360° conduction angle (F = 50 Hz)	3.2	°C/W

GATE CHARACTERISTICS (maximum values)

 $P_{GM} = 40 \text{ W (} t = 10 \mu\text{s)}$ $P_{G(AV)} = 1 \text{ W}$ $I_{GM} = 4 \text{ A (} t = 10 \mu\text{s)}$ $V_{GM} = 16 \text{ V (} t = 10 \mu\text{s)}$

SGS-THOMSON

ELECTRICAL CHARACTERISTICS

Symbol	Test Conditions	Quadrants	Min.	Typ.	Max.	Unit
I_{GT}	$T_j = 25 \text{ °C}$ $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ Pulse duration > 20 μs	I-II-III	2		75	mA
V_{GT}	$T_j = 25 \text{ °C}$ $V_D = 12 \text{ V}$ $R_L = 33 \text{ } \Omega$ Pulse duration > 20 μs	I-II-III			1.5	V
V_{GD}	$T_j = 125 \text{ °C}$ $V_D = V_{DRM}$ $R_L = 3.3 \text{ k}\Omega$ Pulse duration > 20 μs	I-II-III	0.2			V
I_H^*	$T_j = 25 \text{ °C}$ $I_T = 100 \text{ mA}$ Gate open $R_L = 140 \text{ } \Omega$				75	mA
I_L	$T_j = 25 \text{ °C}$ $V_D = 12 \text{ V}$ Pulse duration > 20 μs	I-III		75		mA
		II		150		
V_{TM}^*	$T_j = 25 \text{ °C}$ $I_{TM} = 11 \text{ A}$ $t_p = 10 \text{ ms}$				1.75	V
I_{DRM}^*	$T_j = 25 \text{ °C}$ $T_j = 125 \text{ °C}$	V_{DRM} rated Gate open			0.01	mA
					2	
dv/dt^*	$T_j = 125 \text{ °C}$ Gate open Linear slope up to 0.67 V_{DRM}		750	1000		V/ μs
$(di/dt)_c^*$	$T_j = 125 \text{ °C}$ V_{DRM} rated Without snubber		10	20		A/ms
t_{gt}	$T_j = 25 \text{ °C}$ $I_T = 11 \text{ A}$ $di_G/dt = 3.5 \text{ A}/\mu\text{s}$ $V_D = V_{DRM}$	I-II-III		2		μs

* For either polarity of electrode A₂ voltage with reference to electrode A₁.

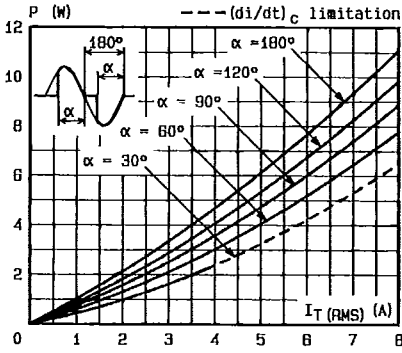


Fig. 1 - Maximum mean power dissipation versus RMS on-state current ($F = 60$ Hz).

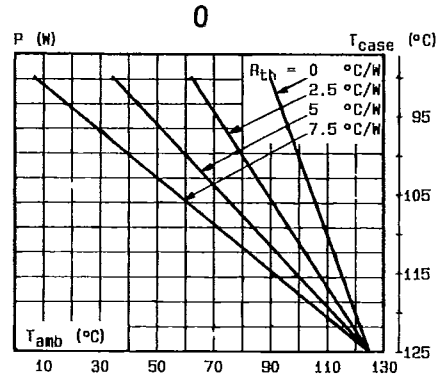


Fig. 2 - Correlation between maximum mean power dissipation and maximum allowable temperatures (T_{amb} and T_{case}) for different thermal resistances heatsink + contact.

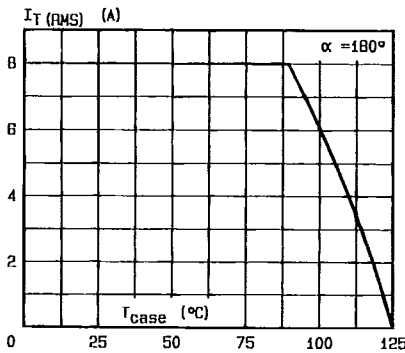


Fig. 3 - RMS on-state current versus case temperature.

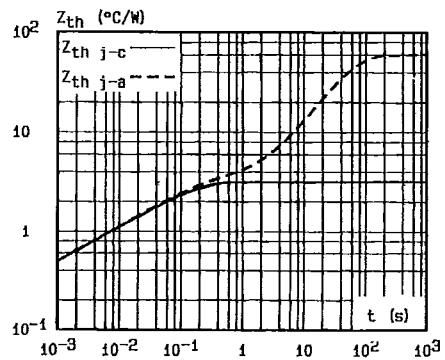


Fig. 4 - Thermal transient impedance junction to case and junction to ambient versus pulse duration.

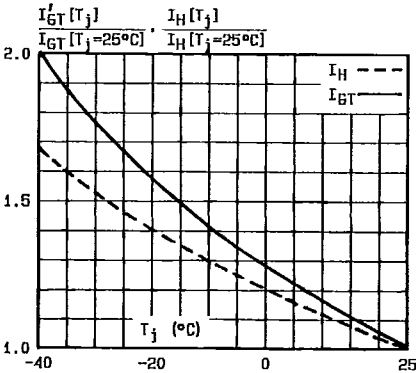


Fig. 5 - Relative variation of gate trigger current and holding current versus junction temperature.

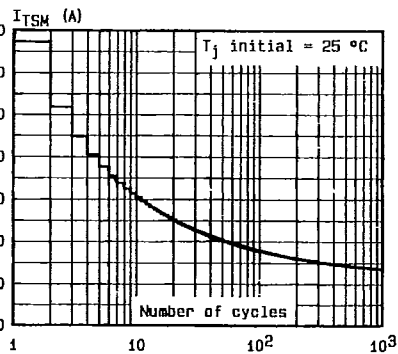


Fig. 6 - Non repetitive surge peak on-state current versus number of cycles.

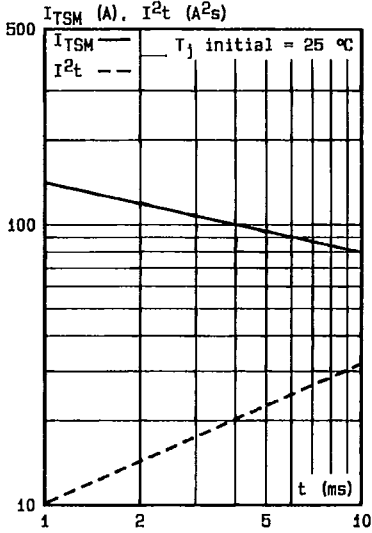


Fig.7 - Non repetitive surge peak on-state current for a sinusoidal pulse with width : $t \leq 10$ ms, and corresponding value of I^2t .

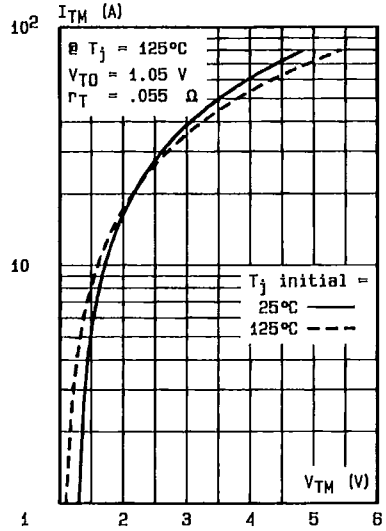
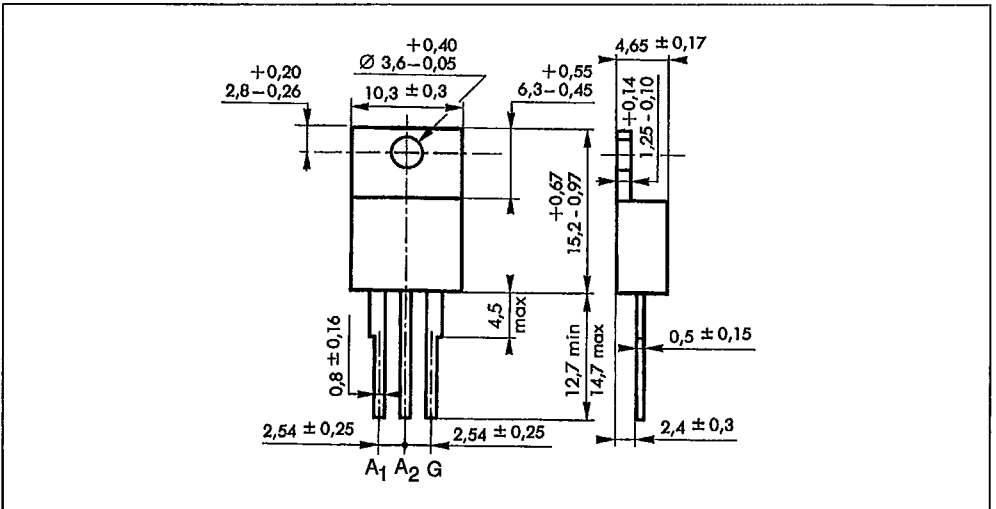


Fig.8 - On-state characteristics (maximum values).

PACKAGE MECHANICAL DATA

TO 220 AB (CB-415) Plastic



Cooling method : by conduction (method C)

Marking : type number

Weight : 2 g